

Special Issue

Selected Papers from 2022 4th International Conference on Blockchain Technology (ICBCT 2022)

Message from the Guest Editors

This Special Issue will provide both academic and industry researchers a forum to present recent advances in the fields of blockchain-enabled IoT. We encourage authors to submit original research articles, case studies, comprehensive reviews and surveys, theoretical and critical perspectives on (but not limited to) the following topics:

- New architecture design for blockchain-enabled IoT;
- Blockchain-based IoT trust management;
- Blockchain-based security mechanism for IoT;
- Blockchain-enabled applications for IoT;
- Identity management of blockchain-based IoT;
- Performance evaluation of blockchain-based IoT;
- Blockchain-based IoT data management;
- High-efficiency consensus protocol for blockchain-based IoT.

Guest Editors

Prof. Dr. Chengnian Long
Prof. Dr. Shaoliang Peng
Dr. Zhitao Guan

Deadline for manuscript submissions

closed (30 November 2022)



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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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